



Scalable high-mobility graphene/hBN heterostructure

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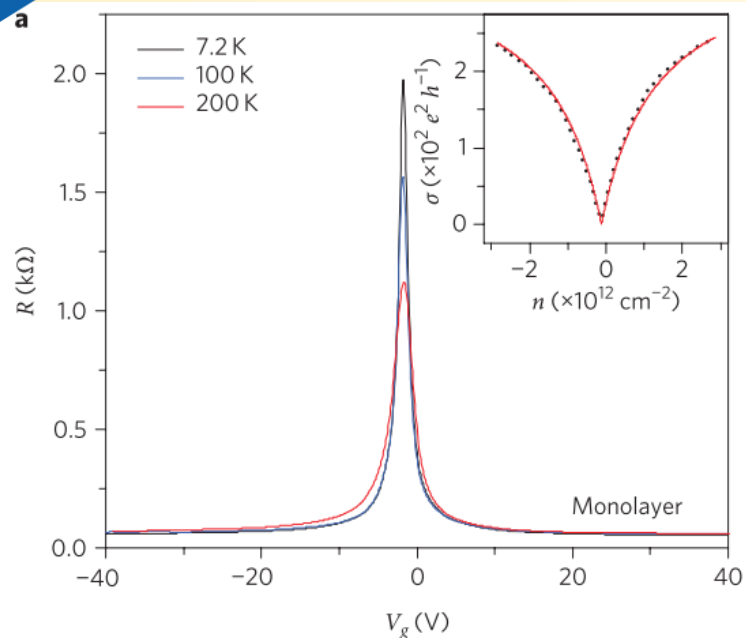
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EUROPEAN CONFERENCE ON CHEMISTRY OF TWO-DIMENSIONAL MATERIALS



Graphene encapsulation



LETTERS

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nature
nanotechnology

Boron nitride substrates for high-quality graphene electronics

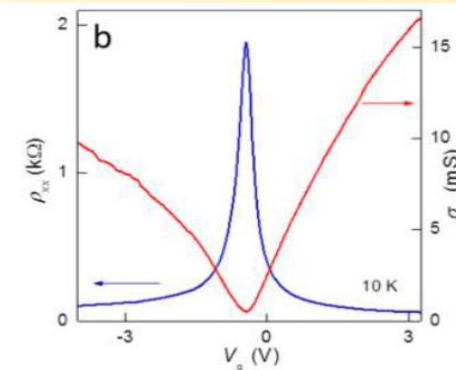
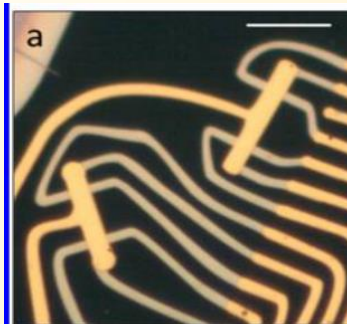
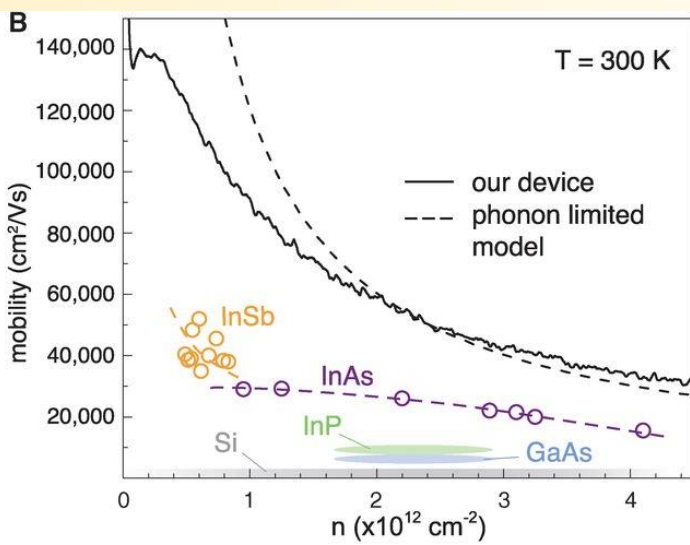
C. R. Dean^{1,2*}, A. F. Young³, I. Meric¹, C. Lee^{4,5}, L. Wang², S. Sorgenfrei¹, K. Watanabe⁶, T. Taniguchi⁶, P. Kim³, K. L. Shepard¹ and J. Hone^{2*}

NANO LETTERS

Letter
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Electronic Properties of Graphene Encapsulated with Different Two-Dimensional Atomic Crystals

A. V. Kretinin,^{*,†} Y. Cao,[†] J. S. Tu,[†] G. L. Yu,[†] R. Jalil,[†] K. S. Novoselov,[‡] S. J. Haigh,[§] A. Gholinia,[§] A. Mishchenko,[‡] M. Lozada,[‡] T. Georgiou,[‡] C. R. Woods,[‡] F. Withers,[†] P. Blake,[†] G. Eda,^{||} A. Wirsig,[⊥] C. Hucho,[⊥] K. Watanabe,[#] T. Taniguchi,[#] A. K. Geim,^{†,‡} and R. V. Gorbachev[†]



REPORT

One-Dimensional Electrical Contact to a Two-Dimensional Material

L. Wang^{1,2*}, I. Meric^{1*}, P. Y. Huang³, Q. Gao⁴, Y. Gao², H. Tran⁵, T. Taniguchi⁶, K. Watanabe⁶, L. M. Campos⁵, D. A. Muller...

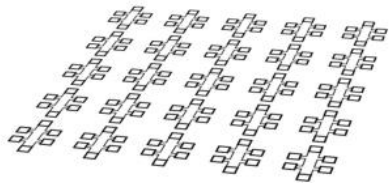
* See all authors and affiliations

Science 01 Nov 2013:
Vol. 342, Issue 6158, pp. 614-617
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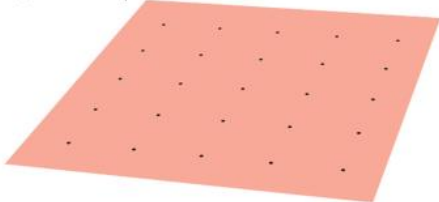


CVD-graphene

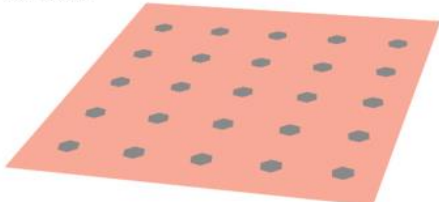
a) Device design



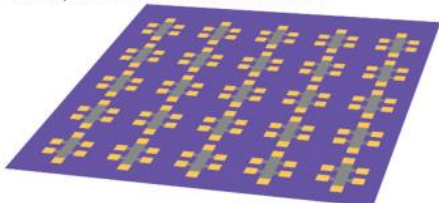
b) Cr seed deposition



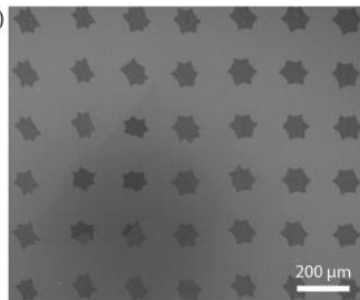
c) Growth



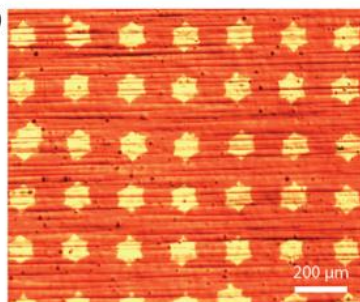
d) Graphene transfer and fabrication



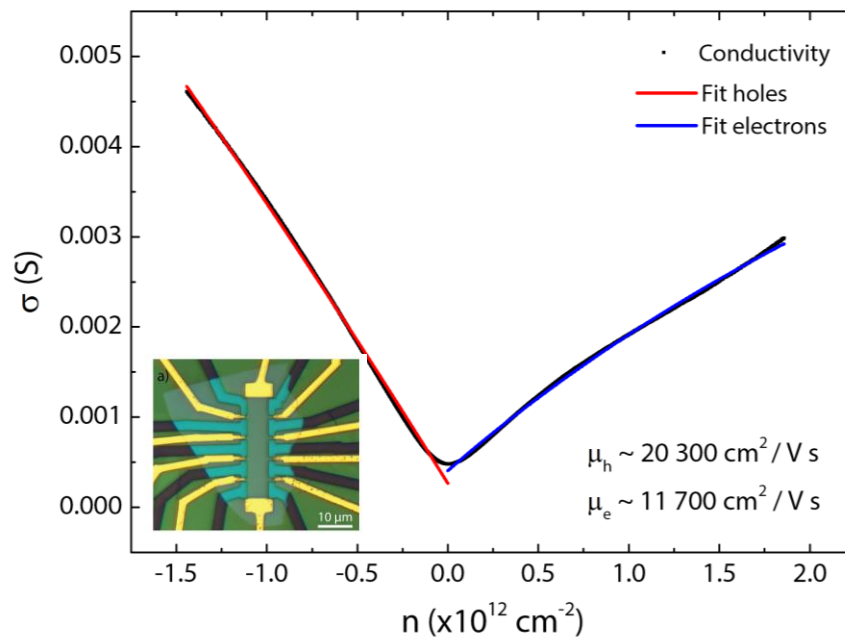
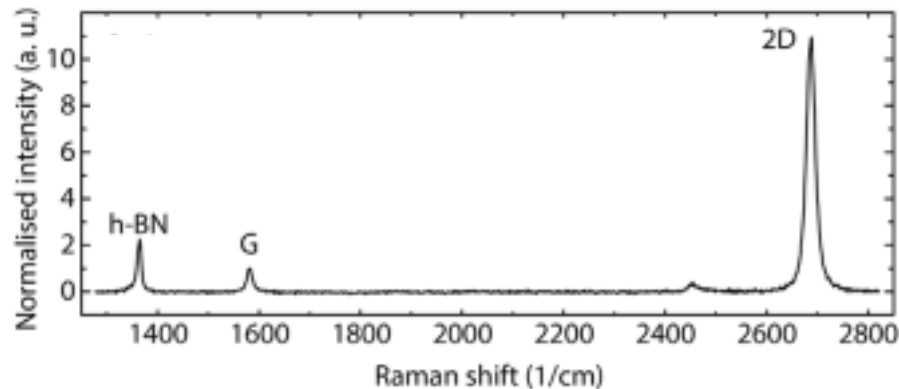
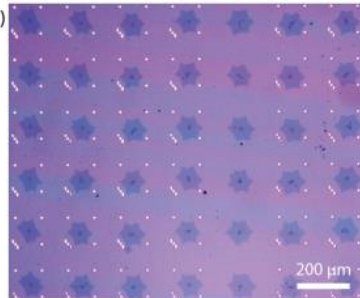
e)



f)



g)











High quality CVD-graphene

2D Materials

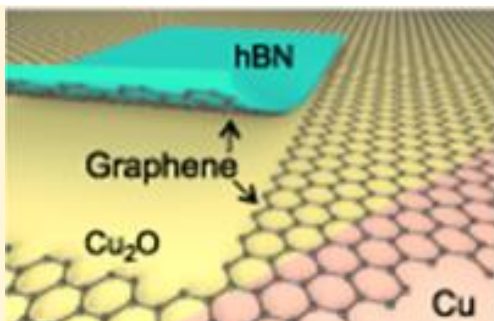
LETTER

High-quality electrical transport using scalable CVD graphene

Sergio Pezzini^{1,2,6} , Vaidotas Mišeikis^{1,2} , Simona Pace^{1,2} , Francesco Rossella³ , Kenji Watanabe⁴ , Takashi Taniguchi⁵ and Camilla Coletti^{1,2} 

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2D Materials

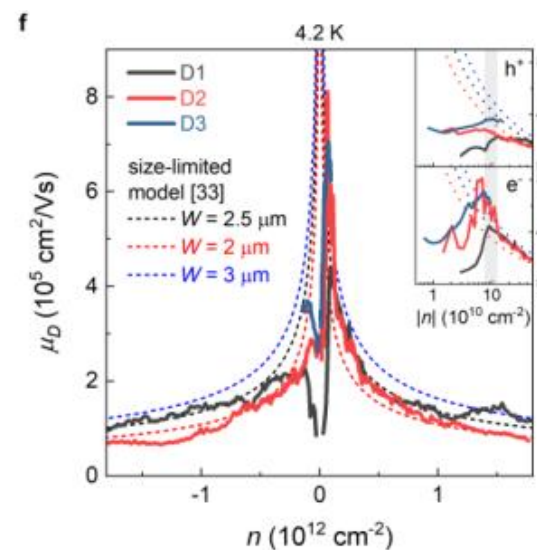
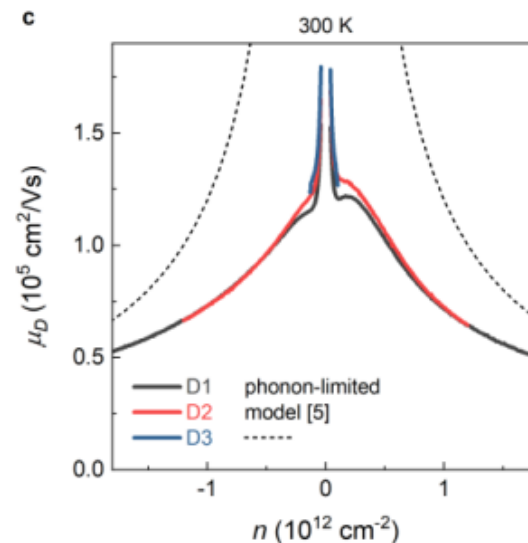
LETTER • OPEN ACCESS

Fractional quantum Hall effect in CVD-grown graphene

M Schmitz^{1,2} , T Ouaj^{1,2}, Z Winter^{1,2}, K Rubi³ , K Watanabe⁴ , T Taniguchi⁵, U Zeitler³, B Beschoten¹  and C Stampfer^{1,2} 

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Scalable hBN sources

ARTICLE

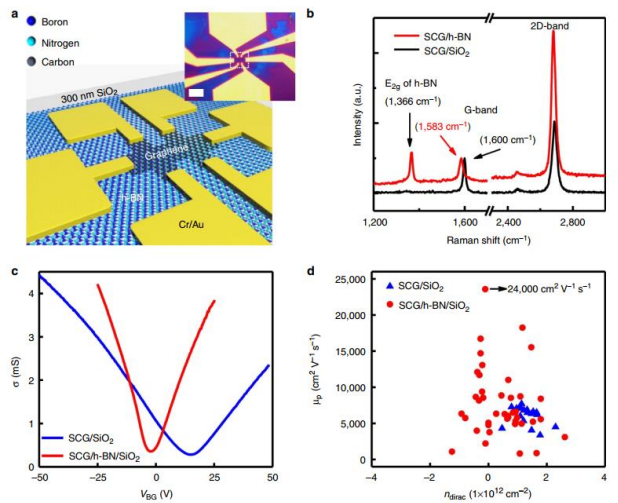
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OPEN

Synthesis of large-area multilayer hexagonal boron nitride for high material performance

Soo Min Kim^{1,2}, Allen Hsu², Min Ho Park³, Sang Hoon Chae^{4,5}, Seok Joon Yun^{4,5}, Joo Song Lee¹, Dae-Hyun Cho⁶, Wenjing Fang², Changgu Lee^{7,8}, Tomás Palacios^{2,9}, Mildred Dresselhaus^{2,9}, Ki Kang Kim¹⁰, Young Hee Lee^{4,5} & Jing Kong²

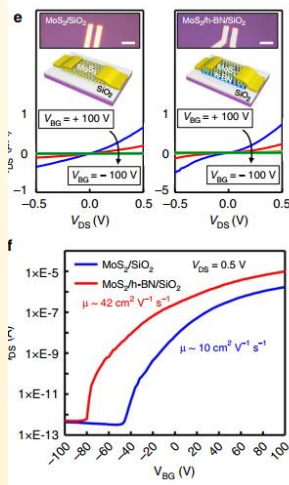


Wafer-Scale and Wrinkle-Free Epitaxial Growth of Single-Orientated Multilayer Hexagonal Boron Nitride on Sapphire

A-Rang Jang,^{†,‡,§} Seokmo Hong,[†] Chohee Hyun,[‡] Seong In Yoon,[‡] Gwangwoo Kim,[‡] Hu Young Jeong,[‡] Tae Joo Shin,[‡] Sung O. Park,[‡] Kester Wong,[‡] Sang Kyu Kwak,[‡] Noejung Park,[‡] Kwangnam Yu,[‡] Eunjip Choi,[‡] Artem Mishchenko,[‡] Freddie Withers,[‡] Kostya S. Novoselov,^{‡,§,||} and Hyeon Suk Shin^{*,†,‡,§,||}

Synthesis and Characterization of Hexagonal Boron Nitride Film as a Dielectric Layer for Graphene Devices

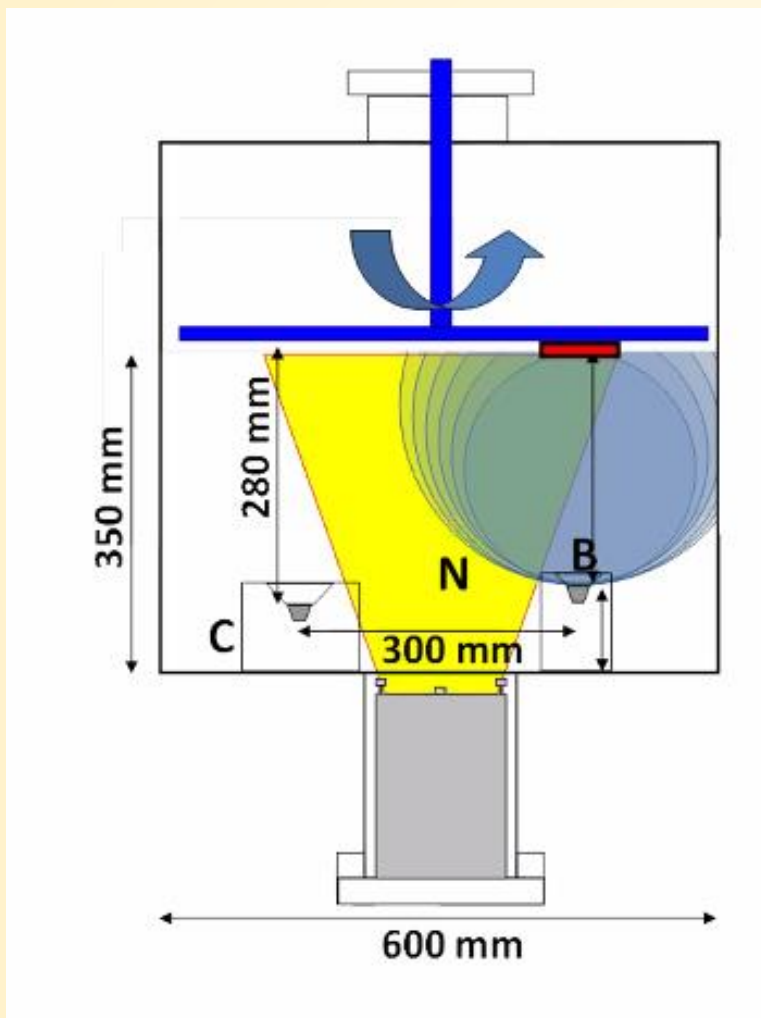
Ki Kang Kim,^{†,‡} Allen Hsu,[†] Xiaoting Jia,[§] Soo Min Kim,[†] Yumeng Shi,[†] Mildred Dresselhaus,^{†,‡} Tomas Palacios,[†] and Jing Kong^{†,*}



It is possible to improve the graphene electrical characteristics, using scalable hBN, but we are still not in pair with exfoliated hBN



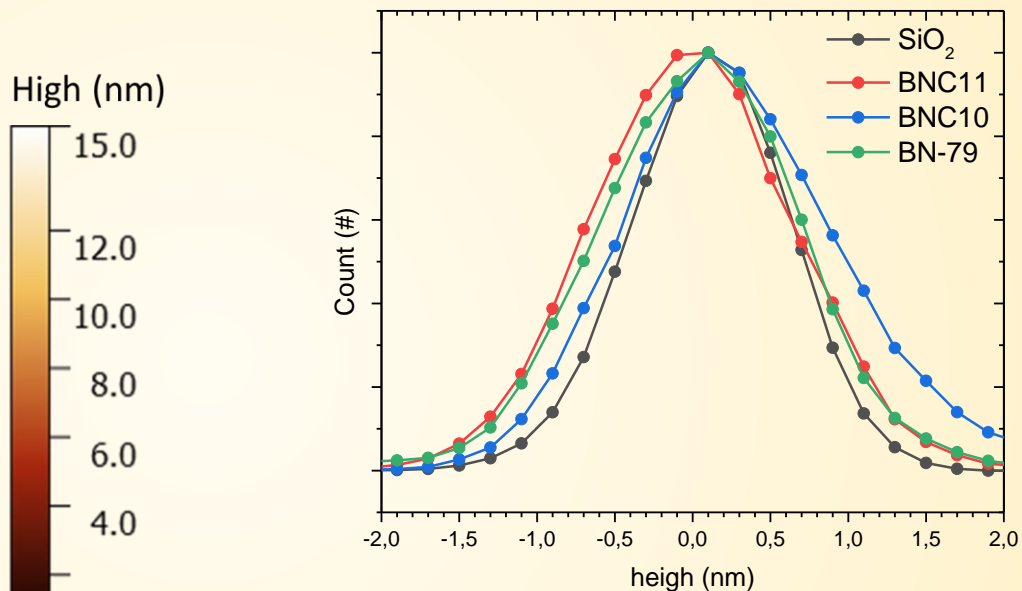
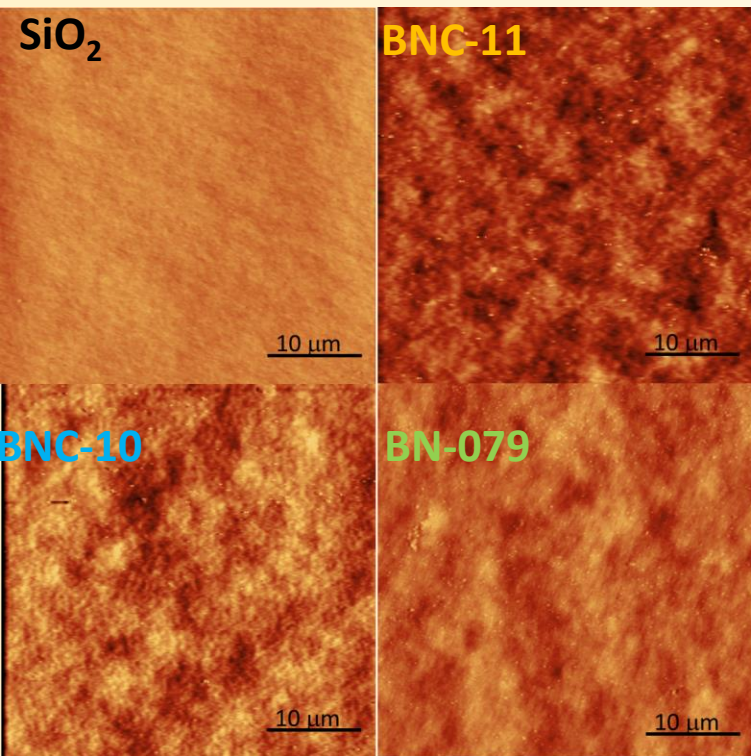
PVD - IBAD hBN growth



- hBN thickness between 10 and 20 nm
- Either hBN with basal plane orientation perpendicular and parallel to the substrate have been studied
- Sample growth with Boron and B_4C as solid precursor has been tested
- Graphene has been successfully transferred on hBN growth from Boron and B_4C precursors, and planar orientation either parallel and orthogonal to the substrate



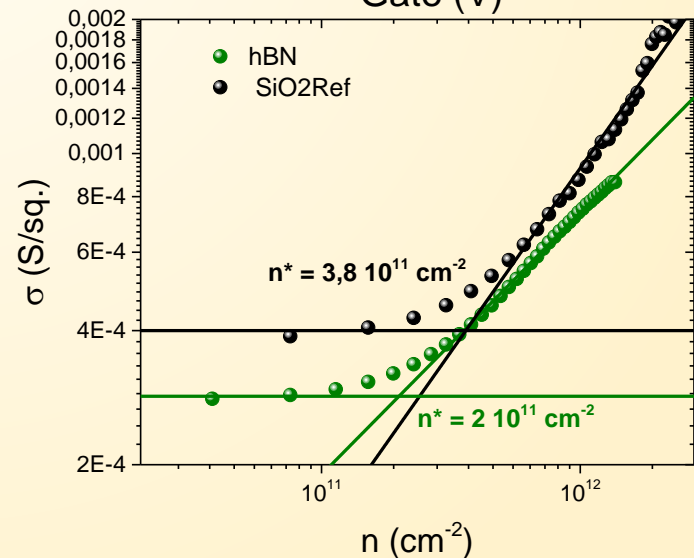
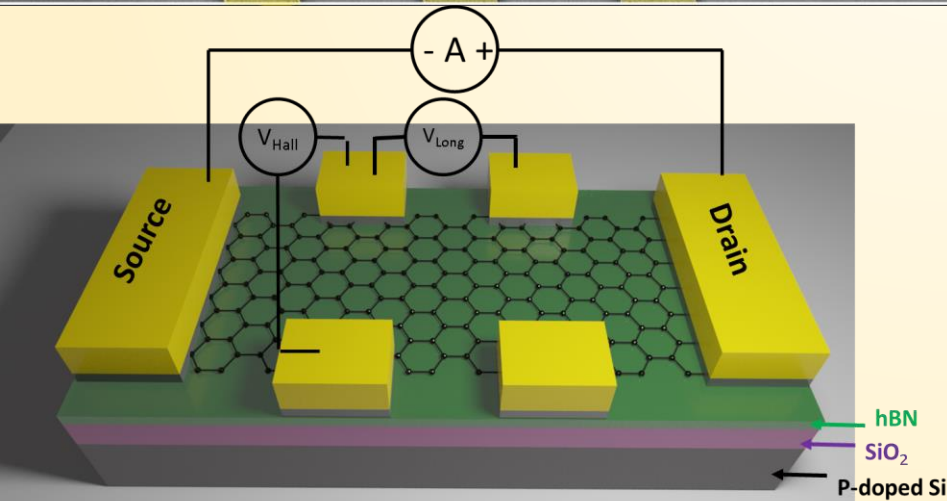
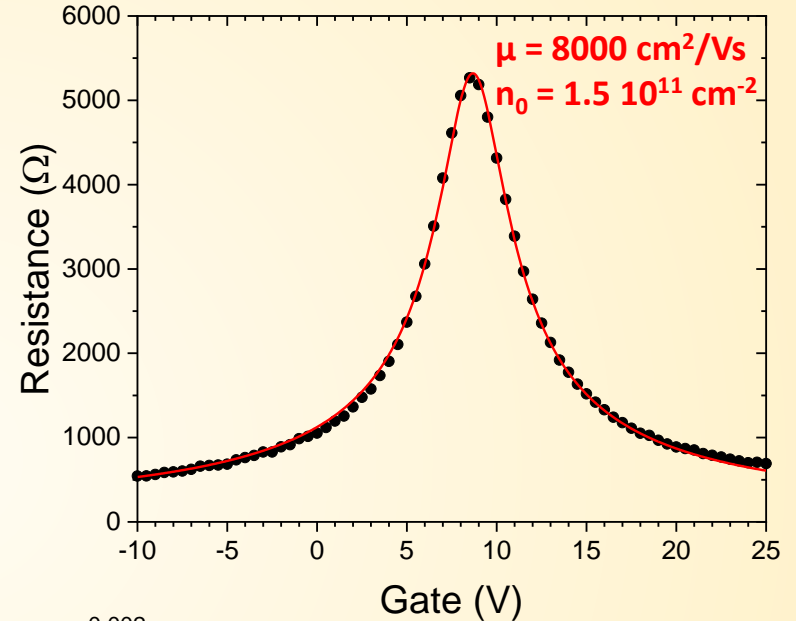
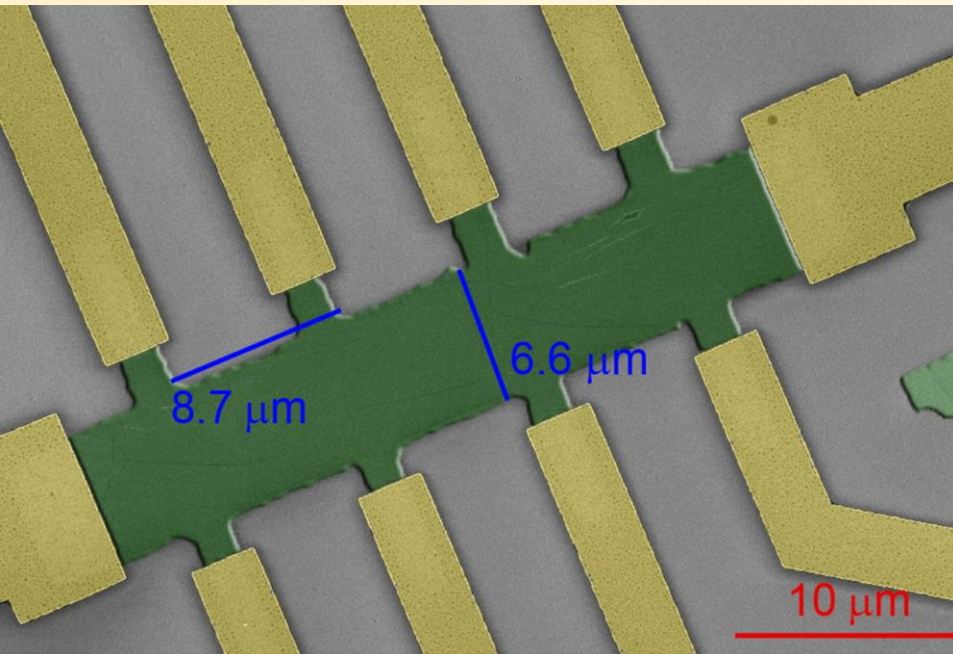
hBN roughness - AFM



Sample name	Substrate	Precursors	Thickness (nm)	Orientation
DE-BN-79	SiO ₂ (300nm)/Si	B(vap) + N ₂ ⁺	10	Parallel
JA-BCN-011	SiO ₂ (300nm)/Si	B ₄ C(vap) + N ₂ ⁺	20	Perpendicular
JA-BCN-010	SiO ₂ (300nm)/Si	B ₄ C(vap) + N ₂ ⁺	10	Parallel

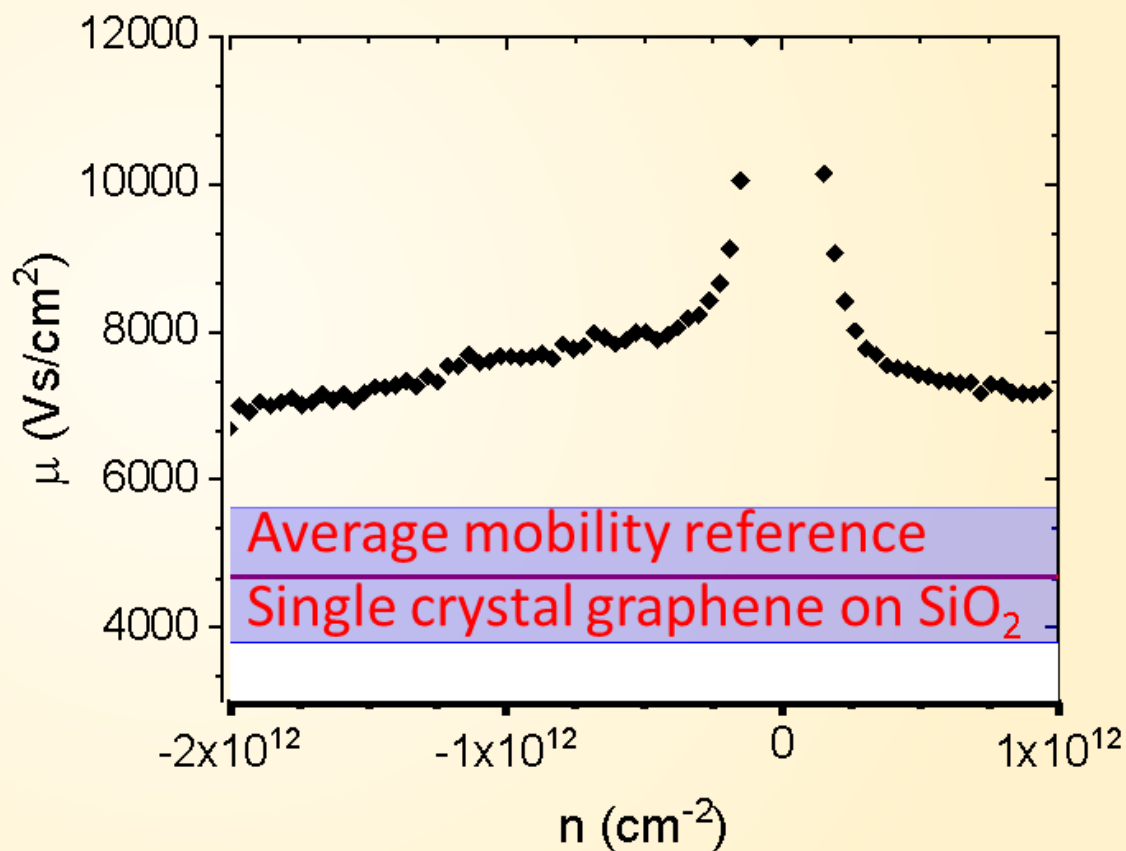
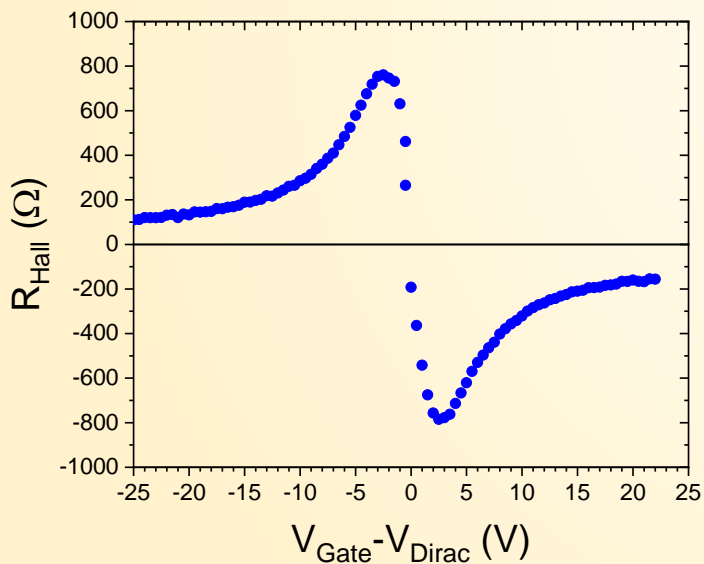
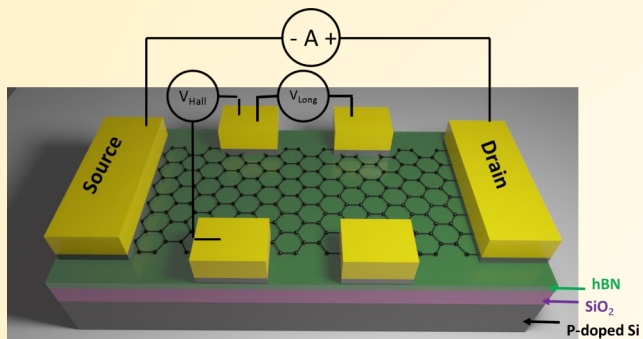


Graphene transfer on hBN: device fabrication



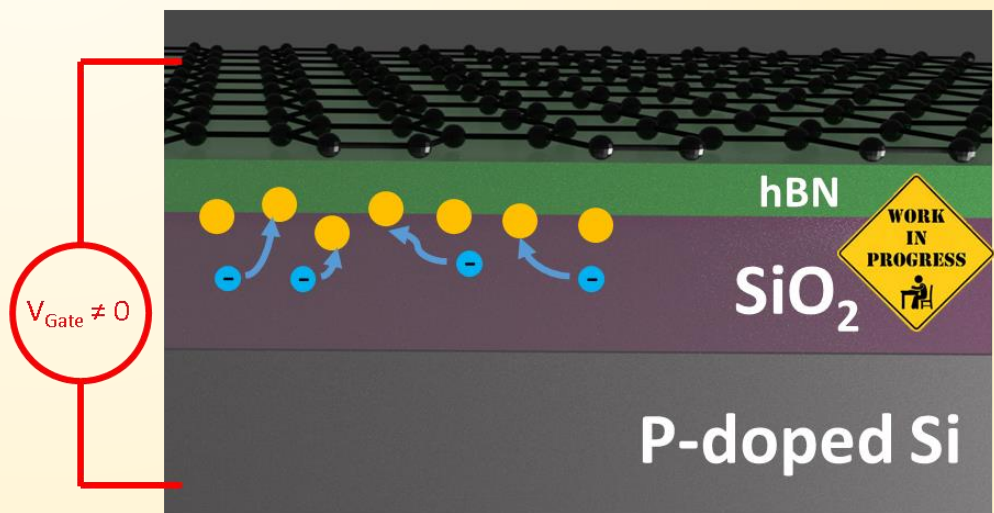
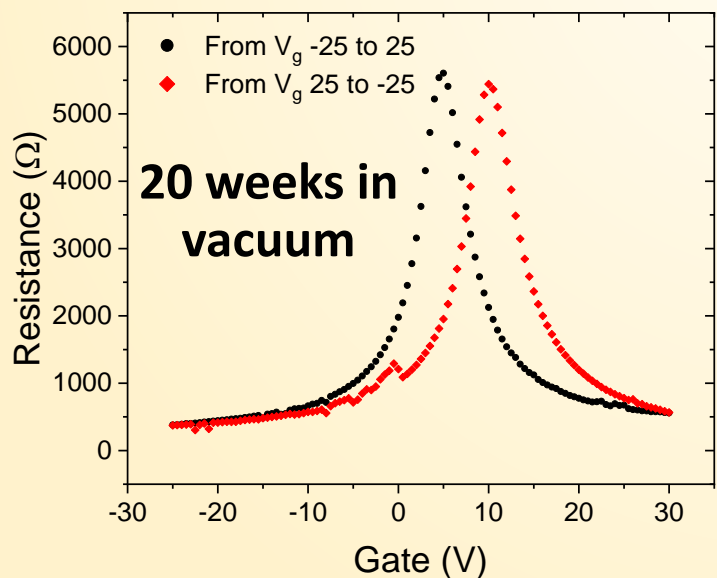
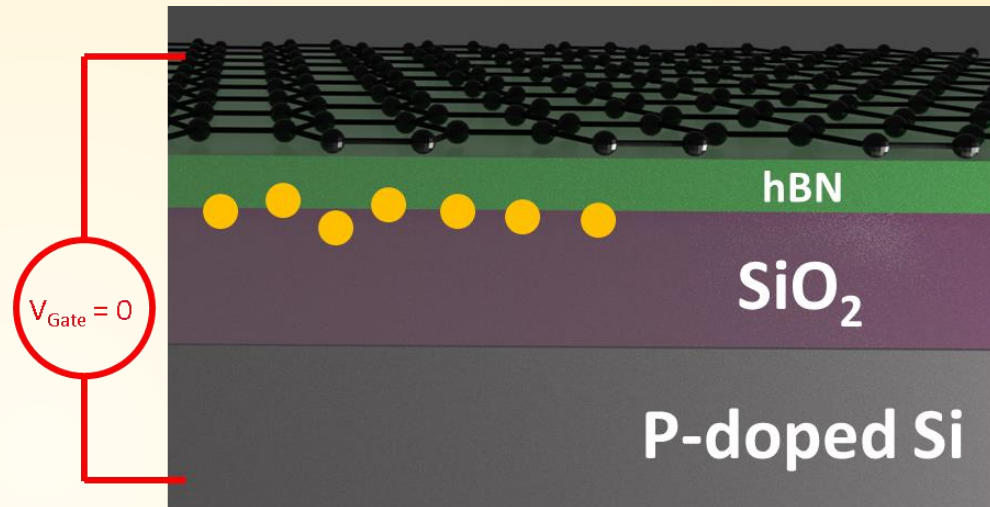
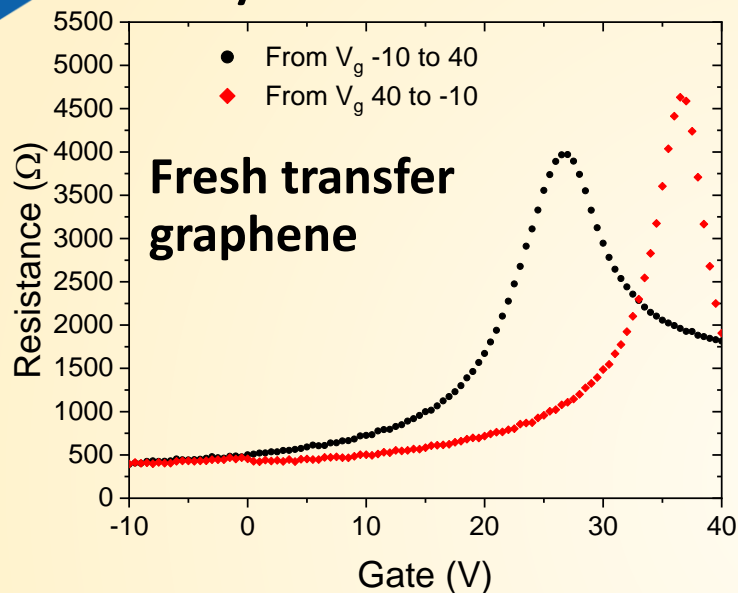


Graphene on hBN: electrical characterization



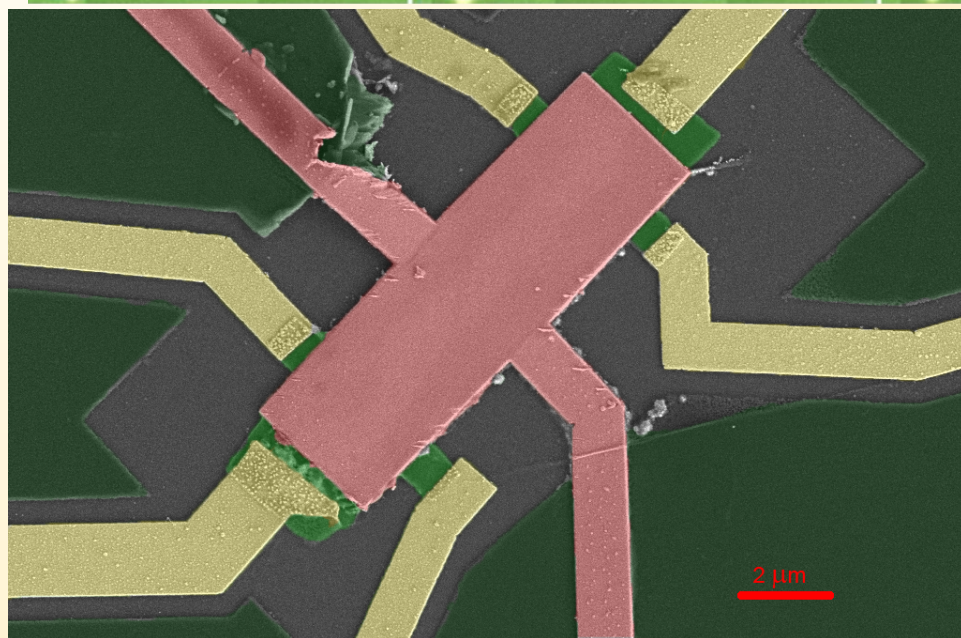
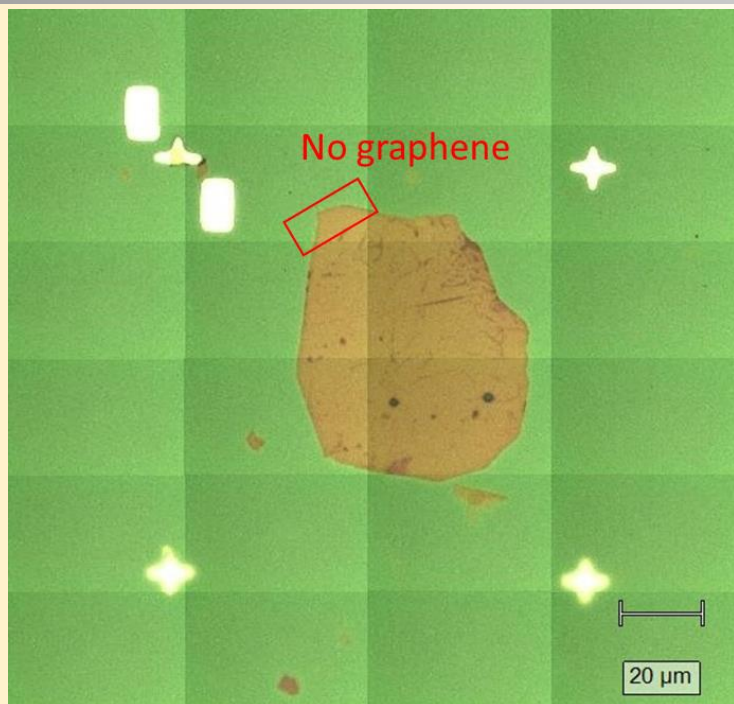
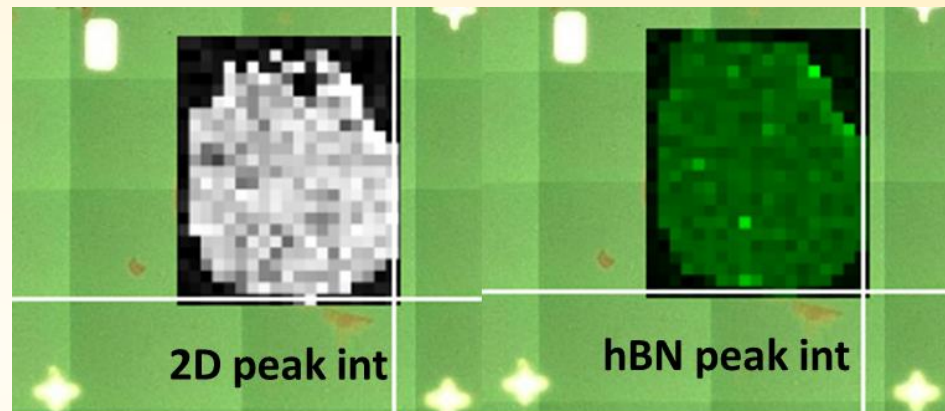
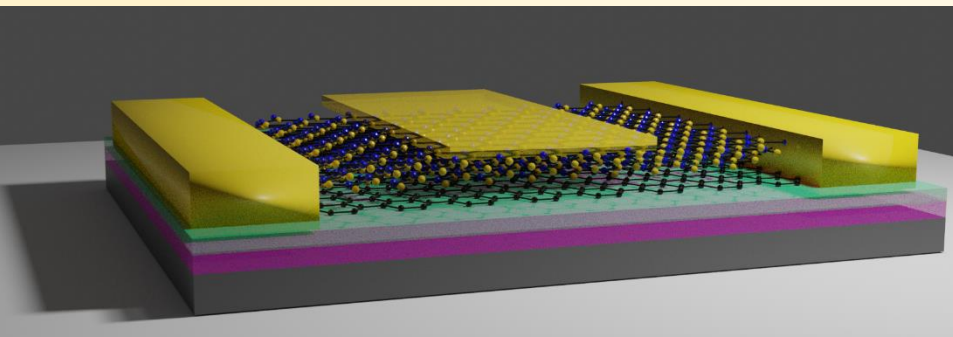


Graphene on hBN: hysteresis in the transfer curve



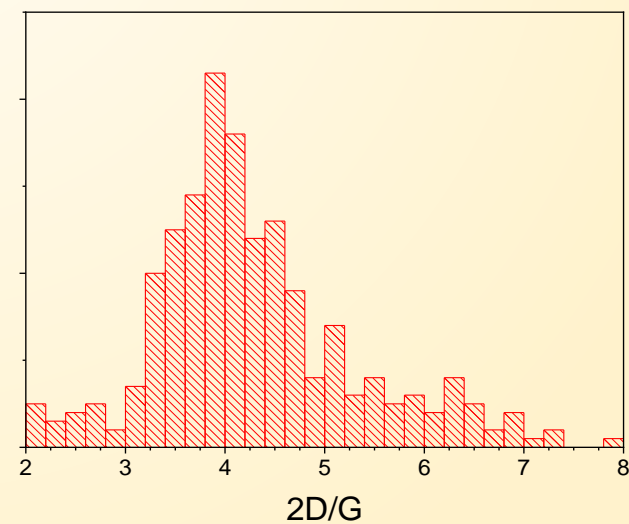
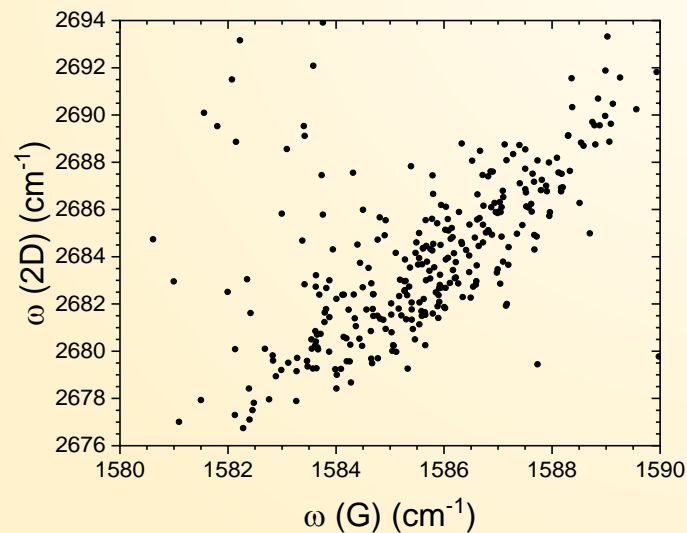
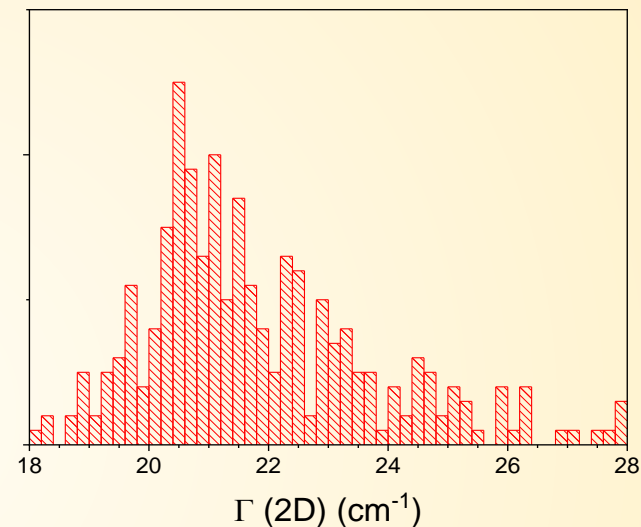
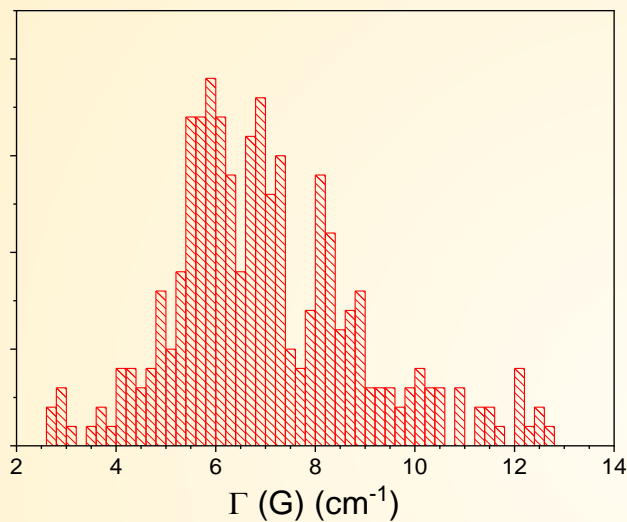


Exfoliated hBN as dielectric for g-FET



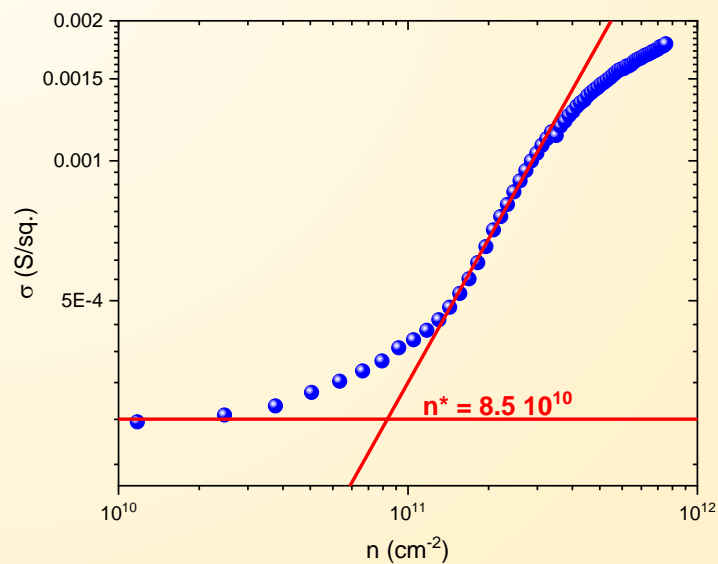
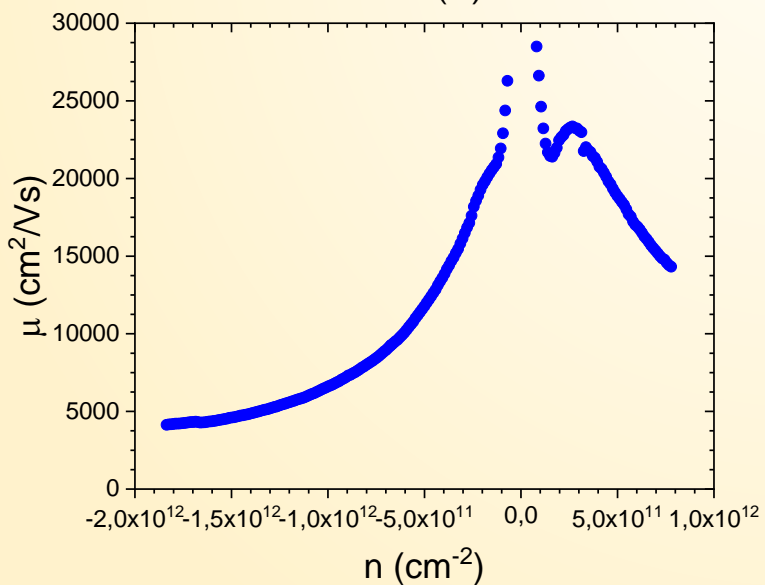
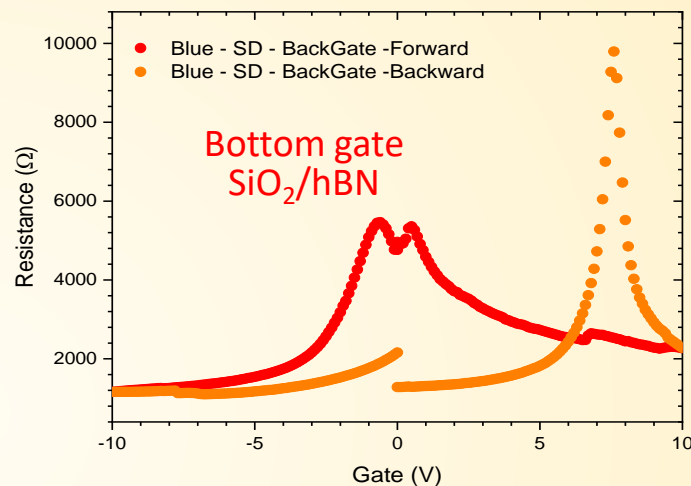
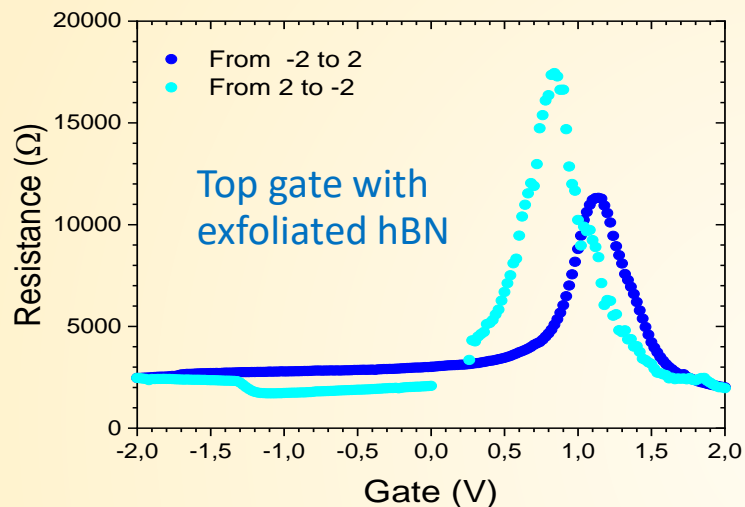


Exfoliated hBN as dielectric for g-FET





Exfoliated hBN as dielectric for g-FET





Conclusion and further perspective

- IBAD grown hBN presents roughness in pair with the growth substrate
- High quality scalable single crystal graphene has been successfully transferred on scalable hBN
- The scalable graphene/hBN stack has been characterized via AFM, Raman spectroscopy and electrically
- Doping of graphene on hBN is comparable with that measured on SiO₂/Si substrates
- Raman indicate strain reduction for graphene on hBN
- RT mobility of grapheme/hBN is ~10 000 cm²/Vs, a factor 1.5 higher than those measured on SiO₂/Si substrate
- RT mobility of **15 000 cm²/Vs** has been measured implementing an exfoliated hBN top gate.
- Further reduction of the roughness could be achieved with a transfer of the hBN film on a pristine substrate
- Characterization of the hBN as dielectric is still under development
- Full-scalable graphene encapsulation, with IBAD-grown hBN



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